

2-Phase Stepper-Motor Driver Bipolar IC

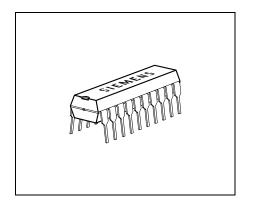
TCA 3727

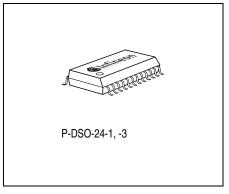
Features

- 2 × 0.75 amp. / 50 V outputs
- Integrated driver, control logic and current control (chopper)
- Fast free-wheeling diodes
- Max. supply voltage 52 V
- Outputs free of crossover current
- Offset-phase turn-ON of output stages
- Z-diode for logic supply
- Low standby-current drain
- Full, half, quarter, mini step



TCA 3727 is a bipolar, monolithic IC for driving bipolar stepper motors, DC motors and other inductive loads that operate on constant current. The control logic and power output stages for two bipolar windings are integrated on a single chip which permits switched current control of motors with 0.75 A per phase at operating voltages up to 50 V.





The direction and value of current are programmed for each phase via separate control inputs. A common oscillator generates the timing for the current control and turn-on with phase offset of the two output stages. The two output stages in a full-bridge configuration have integrated, fast free-wheeling diodes and are free of crossover current. The logic is supplied either separately with 5 V or taken from the motor supply voltage by way of a series resistor and an integrated Z-diode. The device can be driven directly by a microprocessor with the possibility of all modes from full step through half step to mini step.

Туре	Ordering Code	Package
TCA 3727	Q67000-A8302	P-DIP-20-6
TCA 3727 G	Q67000-A8335	P-DSO-24-3

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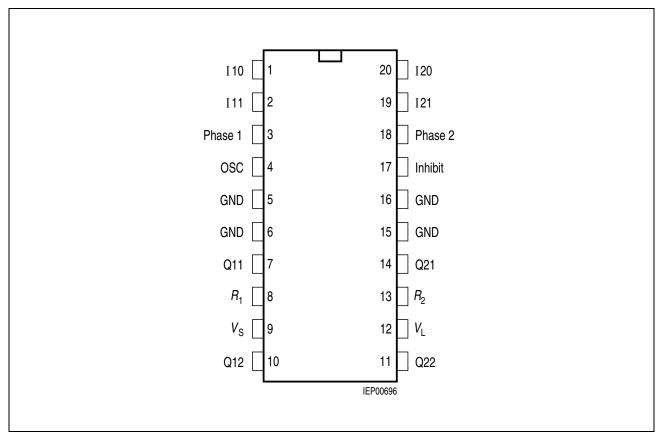


Figure 1 Pin Configuration TCA 3727 (top view)

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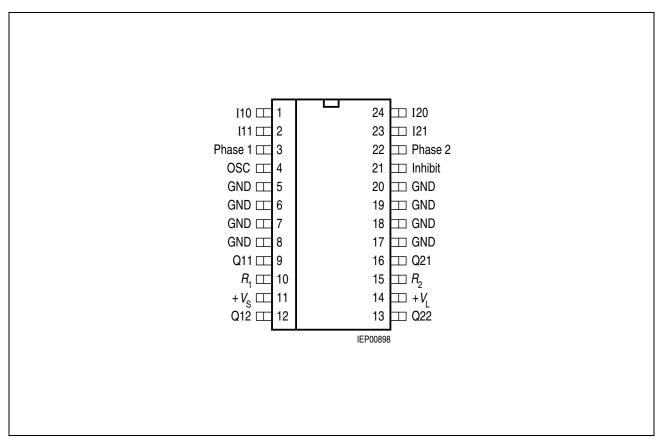


Figure 2 Pin Configuration TCA 3727 G (top view)

Table 1 Pin Definitions and Functions

Pin No.	Function
1, 2, 19, 20 (1, 2, 23, 24) ¹⁾	Digital control inputs IX0, IX1 for the magnitude of the current of the particular phase. See Table 2 .
3	Input Phase 1; controls the current through phase winding 1. On H-potential the phase current flows from Q11 to Q12, on L-potential in the reverse direction.
5, 6, 15, 16 (5, 6, 7, 8, 17, 18, 19, 20) ¹⁾	Ground; all pins are connected internally.
4	Oscillator; works at approx. 25 kHz if this pin is wired to ground across 2.2 nF.
8 (10) ¹⁾	Resistor R_1 for sensing the current in phase 1.
7, 10 (9, 12) ¹⁾	Push-pull outputs Q11, Q12 for phase 1 with integrated free- wheeling diodes.

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 Table 1
 Pin Definitions and Functions (cont'd)

Pin No.	Function					
9 (11) ¹⁾	Supply voltage ; block to ground, as close as possible to the IC, with a stable electrolytic capacitor of at least 10 μF in parallel with a ceramic capacitor of 220 nF.					
12 (14) ¹⁾	Logic supply voltage ; either supply with 5 V or connect to $+V_{\rm S}$ across a series resistor. A Z-diode of approx. 7 V is integrated. In both cases block to ground directly on the IC with a stable electrolytic capacitor of 10 μ F in parallel with a ceramic capacitor of 100 nF.					
11, 14 (13, 16) ¹⁾	Push-pull outputs Q22, Q21 for phase 2 with integrated free wheeling diodes.					
13 (15) ¹⁾	Resistor R_2 for sensing the current in phase 2.					
17 (21) ¹⁾	Inhibit input; the IC can be put on standby by low potential on this pin. This reduces the current consumption substantially.					
18 (22) ¹⁾	Input phase 2; controls the current flow through phase winding 2. On H-potential the phase current flows from Q21 to Q22, on L potential in the reverse direction.					

¹⁾ TCA 3727 G only

Table 2 Digital Control Inputs IX0, IX1

typical $I_{\rm max}$ with $R_{\rm sense}$ = 1 Ω , 750 mA

IX1	IX0	Phase Current	Example of Motor Status
Н	Н	0	No current
Н	L	1/3 I _{max}	Hold
L	Н	2/3 I _{max}	Set
L	L	$I_{\sf max}$	Accelerate

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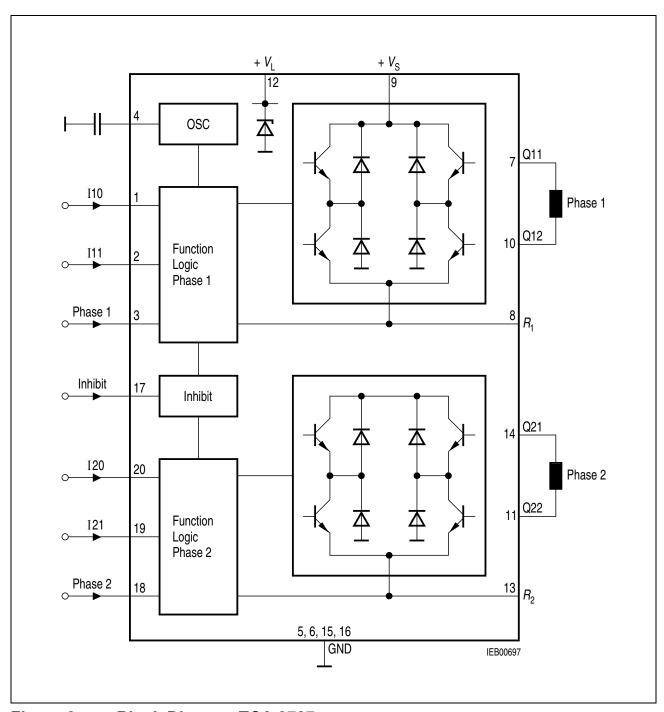


Figure 3 Block Diagram TCA 3727



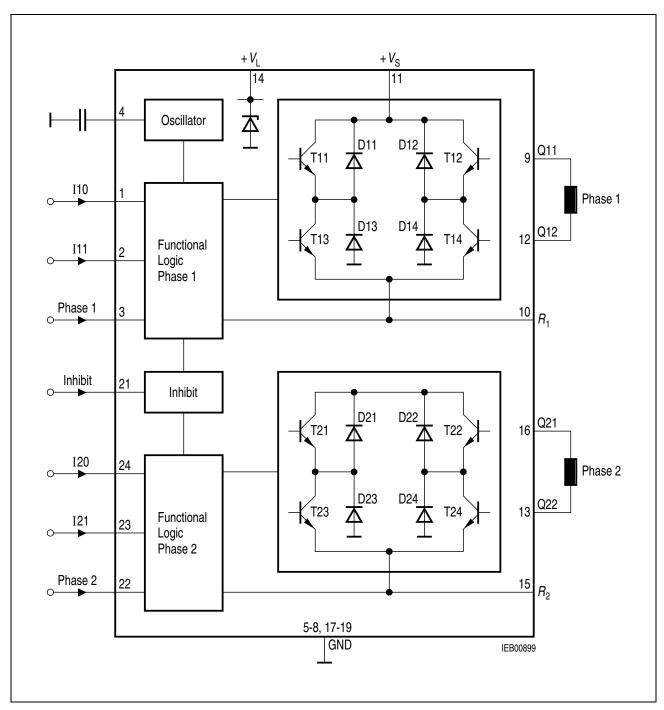


Figure 4 Block Diagram TCA 3727 G



Table 3 Absolute Maximum Ratings

 $T_{\rm A}$ = -40 to 125 °C

Parameter	Symbol	Limit	Values	Unit	Remarks	
		Min.	Max.			
Supply voltage	V_{S}	0	52	V	_	
Logic supply voltage	V_{L}	0	6.5	V	Z-diode	
Z-current of V_{L}	I_{L}	_	50	mA	_	
Output current	I_{Q}	-1	1	Α	-	
Ground current	I_{GND}	-2	2	Α	_	
Logic inputs	V_{IXX}	-6	V _L + 0.3	V	IXX; Phase 1, 2; Inhibit	
R_1 , R_2 , oscillator input voltage	$V_{\mathrm{RX,}} \ V_{\mathrm{OSC}}$	-0.3	V _L + 0.3	V	-	
Junction temperature	T_{j}	_	125	°C	_	
			150	°C	max. 10,000 h	
Storage temperature	$T_{ m stg}$	-50	125	°C	_	

Attention: Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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Table 4 Operating Range

Parameter	Symbol	Limit Values		Unit	Remarks	
		Min.	Max.			
Supply voltage	V_{S}	5	50	V	_	
Logic supply voltage	V_{L}	4.5	6.5	V	without series resistor	
Case temperature	T_{C}	-40	110	°C	$\begin{array}{c} \text{measured on pin 5} \\ P_{\text{diss}} = 2 \text{ W} \end{array}$	
Output current	I_{Q}	-1000	1000	mA	_	
Logic inputs	V_{IXX}	-5	V_{L}	V	IXX; Phase 1, 2; Inhibit	
Thermal Resistances						
Junction ambient	R_{thja}	_	56	K/W	P-DIP-20-6	
Junction ambient (soldered on a 35 μm thick 20 cm ² PC board copper area)	R_{thja}	_	40	K/W	P-DIP-20-6	
Junction case	R_{thjc}	_	18	K/W	measured on pin 5 P-DIP-20-6	
Junction ambient	R_{thja}	_	75	K/W	P-DSO-24-3	
Junction ambient (soldered on a 35 μm thick 20 cm ² PC board copper area)	R _{th ja}	_	50	K/W	P-DSO-24-3	
Junction case	R_{thjc}	_	15	K/W	measured on pin 5 P-DSO-24-3	

Note: In the operating range, the functions given in the circuit description are fulfilled.

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Table 5 Characteristics

 $V_{\rm S}$ = 40 V; $V_{\rm L}$ = 5 V; -25 °C $\leq T_{\rm j} \leq$ 125 °C

Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Тур.	Max.		
Current Consumption	•	•	•	•		
$from + V_S$	I_{S}	_	0.2	0.5	mA	$V_{inh} = L$
from + $V_{\rm S}$	I_{S}	_	16	20	mA	$\begin{split} V_{\rm inh} &= {\rm H} \\ I_{\rm Q1/2} &= 0, {\rm IXX} = {\rm L} \end{split}$
$from + V_L$	I_{L}	_	1.7	3	mA	$V_{inh} = L$
from + $V_{\rm L}$	I_{L}	_	18	25	mA	$V_{\rm inh}$ = H $I_{\rm Q1/2}$ = 0, IXX = L
Oscillator						
Output charging current	I_{OSC}	_	110	_	μΑ	_
Charging threshold	V_{OSCL}	_	1.3	_	V	_
Discharging threshold	V_{OSCH}	_	2.3	_	V	_
Frequency	$f_{\rm OSC}$	18	25	35	kHz	$C_{\rm OSC}$ = 2.2 nF
Phase Current Selection Current Limit Threshold	• • •					
No current	$V_{ m sense\ n}$	_	0	_	mV	IX0 = H; IX1 = H
Hold	$V_{ m sense\ h}$	200	250	300	mV	IX0 = L; IX1 = H
Setpoint	$V_{\mathrm{sense\ s}}$	460	540	620	mV	IX0 = H; IX1 = L
Accelerate	$V_{ m sense}$ a	740	825	910	mV	IX0 = L; IX1 = L
Logic Inputs (IX1; IX0; P	hase x)					
Threshold	V_1	1.4 (H→L)	_	2.3 (L→H)	V	_
L-input current	I_{IL}	-10	_	_	μΑ	V _I = 1.4 V
L-input current	I_{IL}	-100	_		μΑ	<i>V</i> _I = 0 V
H-input current	I_{IH}	_	_	10	μΑ	V _I = 5 V
Standby Cutout (inhibit)						
Threshold	V_{Inh} (L \rightarrow H)	2	3	4	V	_
Threshold	$V_{\rm lnh} \ ({\rm H}{ ightarrow}{ m L})$	1.7	2.3	2.9	V	_
Hysteresis	V_{Inhhy}	0.3	0.7	1.1	V	_

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Table 5 Characteristics (cont'd)

 $V_{\rm S}$ = 40 V; $V_{\rm L}$ = 5 V; -25 °C $\leq T_{\rm i} \leq$ 125 °C

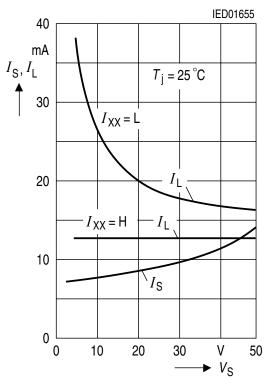
Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Typ.	Max.		
Internal Z-Diode	·					
Z-voltage	V_{LZ}	6.5	7.4	8.2	V	$I_{\rm L}$ = 50 mA
Power Outputs						
Diode Transistor Sink P	Pair (D13, T1	3; D14,	T14; D2	23, T23;	D24, T	24)
Saturation voltage	V_{satl}	_	0.3	0.6	V	$I_{\rm Q}$ = -0.5 A
Saturation voltage	V_{satl}	_	0.5	1	V	$I_{\rm Q}$ = -0.75 A
Reverse current	I_{RI}	_	_	300	μА	V _Q = 40 V
Forward voltage	V_{FI}	_	0.9	1.3	V	$I_{\rm Q}$ = 0.5 A
Forward voltage	V_{FI}	_	1	1.4	V	$I_{\rm Q}$ = 0.75 A
Diode Transistor Sourc	e Pair (D11,	T11; D1	I2, T12;	D21, T2	21; D22	2, T22)
Saturation voltage	$V_{\sf satuC}$	_	0.9	1.2	V	$I_{\rm Q}$ = 0.5 A; charge
Saturation voltage	V_{satuD}	_	0.3	0.7	V	$I_{\rm Q}$ = 0.5 A; discharge
Saturation voltage	$V_{\sf satuC}$	_	1.1	1.4	V	$I_{\rm Q}$ = 0.75 A; charge
Saturation voltage	$V_{\sf satuD}$	_	0.5	1	V	$I_{\rm Q}$ = 0.75 A; discharge
Reverse current	I_{Ru}	_	_	300	μΑ	$V_{Q} = 0 \text{ V}$
Forward voltage	V_{Fu}	_	1	1.3	V	$I_{\rm Q}$ = -0.5 A
Forward voltage	V_{Fu}	_	1.1	1.4	V	$I_{\rm Q}$ = -0.75 A
Diode leakage current	I_{SL}	_	1	2	mA	$I_{\rm F}$ = -0.75 A

Note: The listed characteristics are ensured over the operating range of the integrated circuit. Typical characteristics specify mean values expected over the production spread. If not otherwise specified, typical characteristics apply at T_A = 25 °C and the given supply voltage.

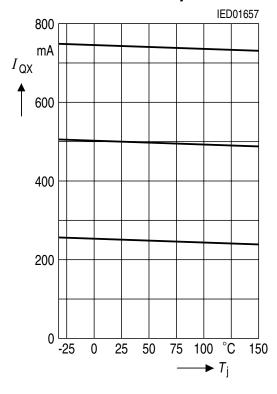
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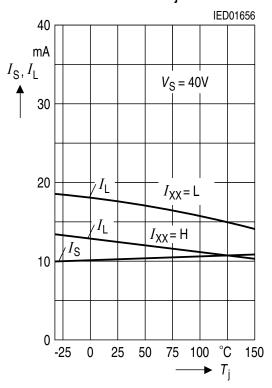
Quiescent Current $I_{\rm S}, I_{\rm L}$ versus Supply Voltage $V_{\rm S}$



Output Current I_{QX} versus Junction Temperature T_{i}



Quiescent Current $I_{\rm S}, I_{\rm L}$ versus Junction Temperature $T_{\rm i}$

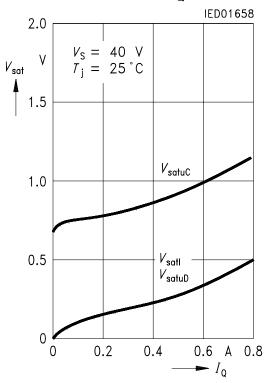


Operating Condition:

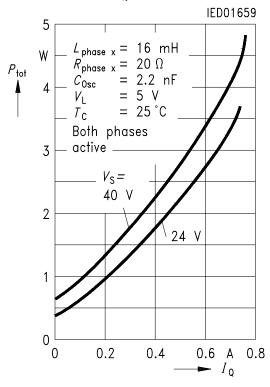
- $V_{\rm L}$ = 5 V
- $V_{lnh} = H$
- $C_{\rm OSC}$ = 2.2 nF
- $R_{\text{sense}} = 1 \Omega$
- Load: L = 10 mH, R = 2.4 Ω
- f_{phase} = 50 Hz
- mode: fullstep



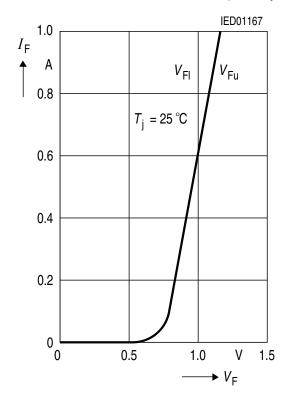
Output Saturation Voltages $V_{\rm sat}$ versus Output Current $I_{\rm Q}$



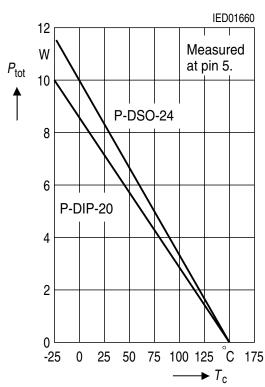
Typical Power Dissipation P_{tot} versus Output Current I_{Q} (non stepping)



Forward Current $I_{\rm F}$ of Free-Wheeling Diodes versus Forward Voltages $V_{\rm F}$

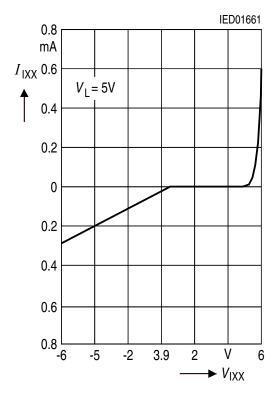


Permissible Power Dissipation P_{tot} versus Case Temperature T_{C}

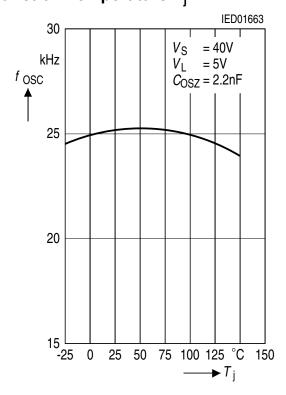




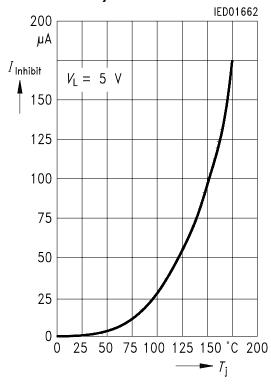
Input Characteristics of IXX, Phase X, Inhibit



Oscillator Frequency $f_{\rm OSC}$ versus Junction Temperature $T_{\rm j}$



Input Current of Inhibit versus Junction Temperature $T_{\rm j}$





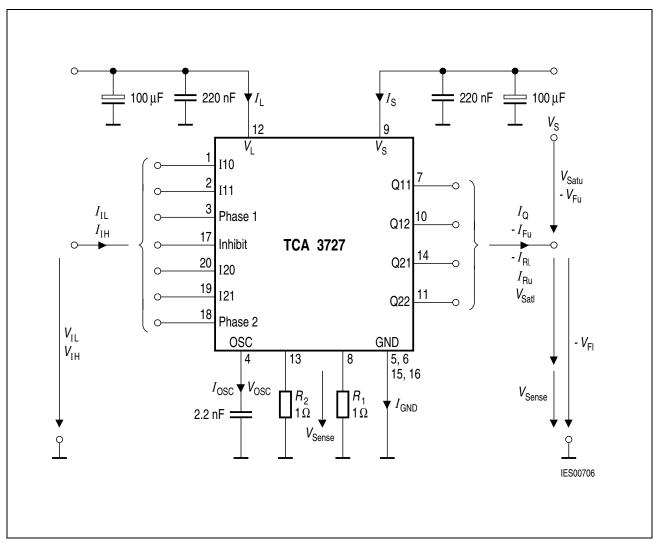


Figure 5 Test Circuit

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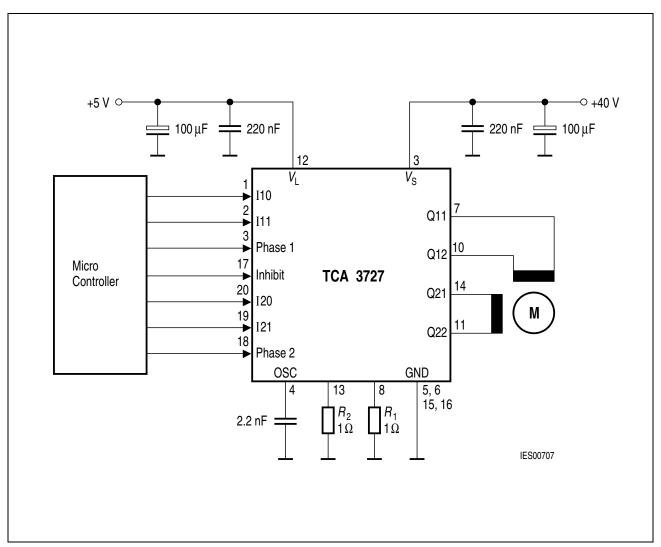


Figure 6 Application Circuit

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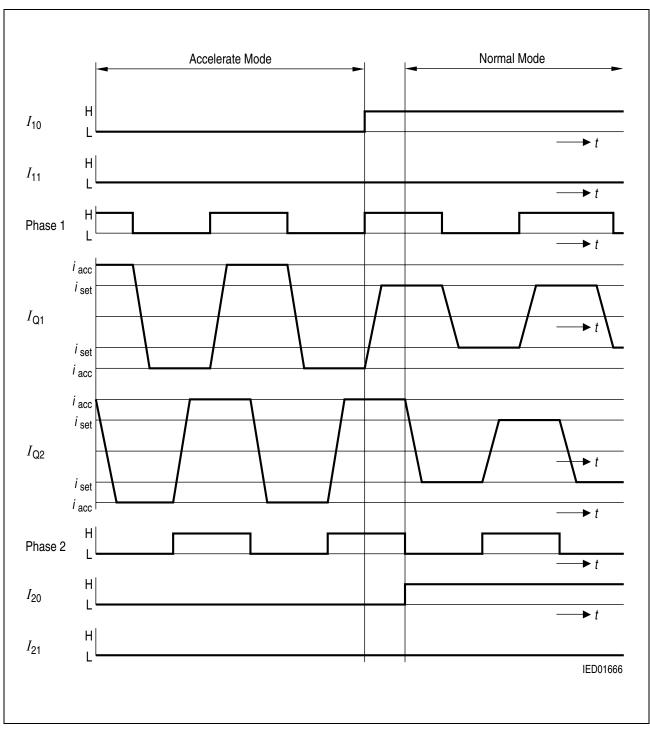


Figure 7 Full-Step Operation



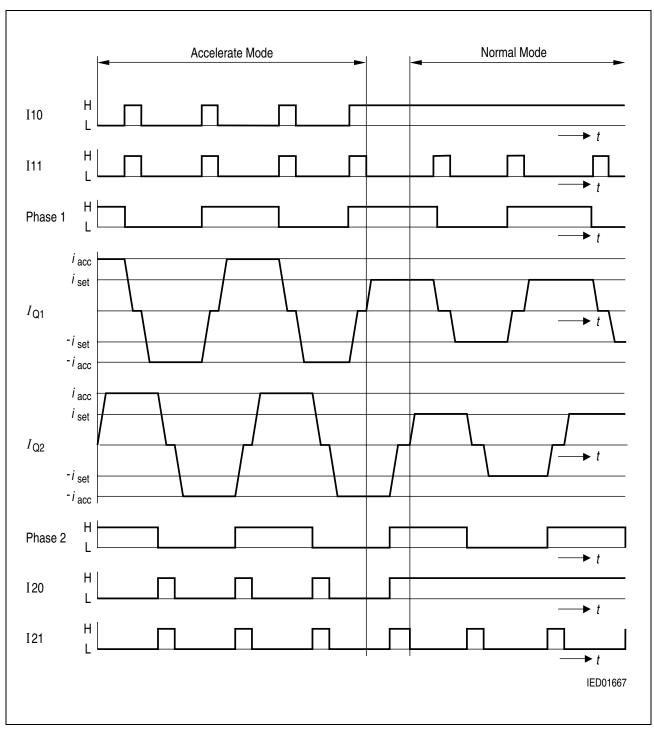


Figure 8 Half-Step Operation



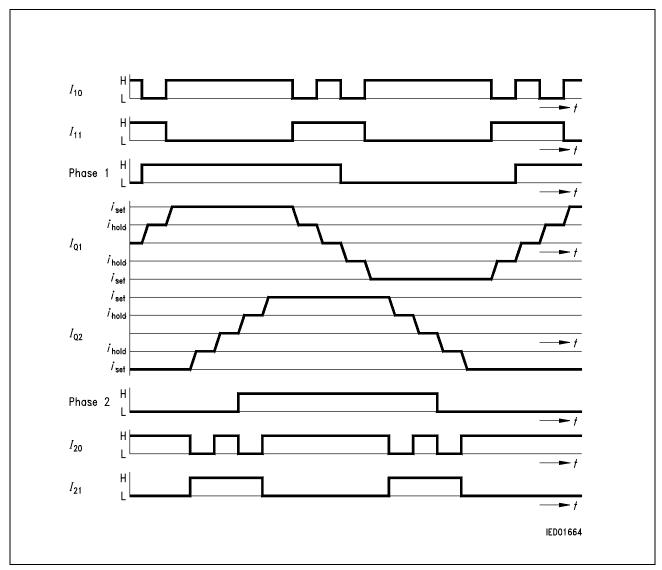


Figure 9 Quarter-Step Operation

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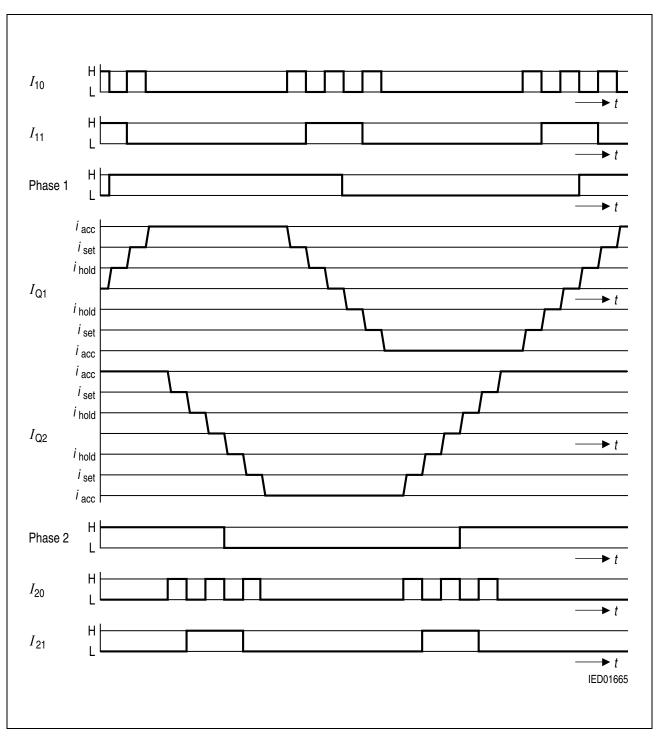


Figure 10 Mini-Step Operation

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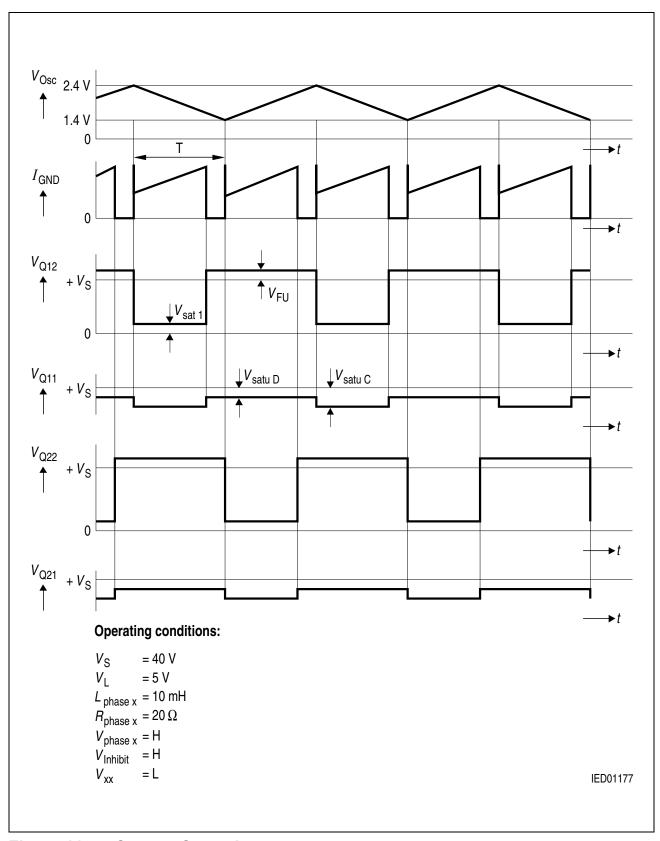


Figure 11 Current Control



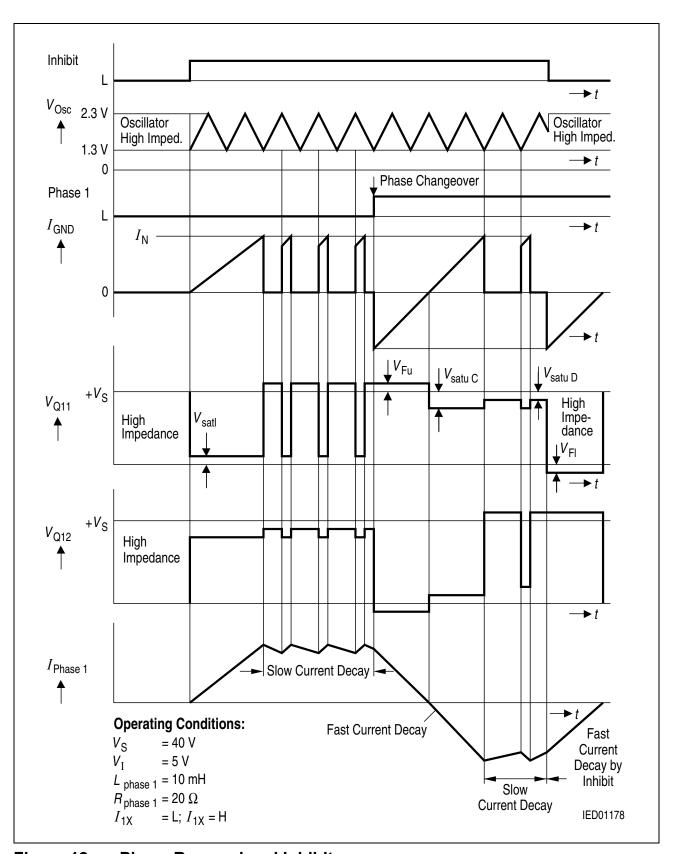


Figure 12 Phase Reversal and Inhibit



Calculation of Power Dissipation

The total power dissipation P_{tot} is made up of

- saturation losses P_{sat} (transistor saturation voltage and diode forward voltages),
- quiescent losses P_q (quiescent current times supply voltage) and
- switching losses P_s (turn-ON / turn-OFF operations).

The following equations give the power dissipation for chopper operation without phase reversal. This is the worst case, because full current flows for the entire time and switching losses occur in addition.

$$P_{\text{tot}} = 2 \times P_{\text{sat}} + P_{\text{q}} + 2 \times P_{\text{s}} \tag{1}$$

where

- $P_{\text{sat}} \cong I_{\text{N}} \{ V_{\text{satl}} \times d + V_{\text{Fu}} (1 d) + V_{\text{satuC}} \times d + V_{\text{satuD}} (1 d) \}$
- $P_{\mathsf{q}} = I_{\mathsf{q}} \times V_{\mathsf{S}} + I_{\mathsf{L}} \times V_{\mathsf{L}}$

$$P_{S} \cong \frac{V_{S}}{T} \left\{ \frac{i_{D} \times t_{DON}}{2} + \frac{i_{D} + i_{R} \times t_{ON}}{4} + \frac{I_{N}}{2} t_{DOFF} + t_{OFF} \right\}$$
 (2)

- I_N = nominal current (mean value)
- I_{a} = quiescent current
- i_D^2 = reverse current during turn-on delay
- i_R = peak reverse current
- t_p = conducting time of chopper transistor
- t_{ON} = turn-ON time
- t_{OFF} = turn-OFF time
- t_{DON} = turn-ON delay
- t_{DOFF} = turn-OFF delay
- T = cycle duration
- d = duty cycle t_p/T
- V_{satt} = saturation voltage of sink transistor (T3, T4)
- $V_{\rm satuC}$ = saturation voltage of source transistor (T1, T2) during charge cycle
- $V_{\rm satuD}$ = saturation voltage of source transistor (T1, T2) during discharge cycle
- $V_{\rm Fu}$ = forward voltage of free-wheeling diode (D1, D2)
- $V_{\rm S}$ = supply voltage
- V_1 = logic supply voltage
- I_L = current from logic supply



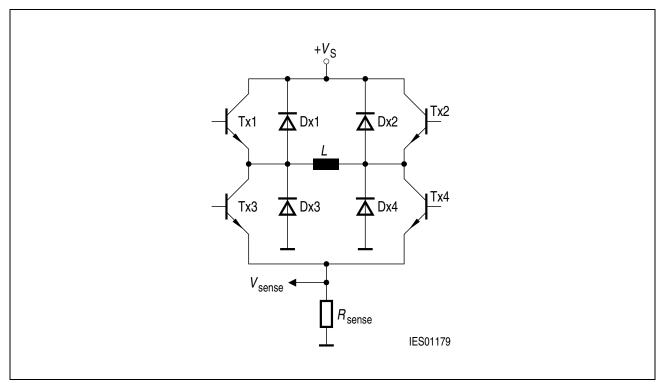


Figure 13

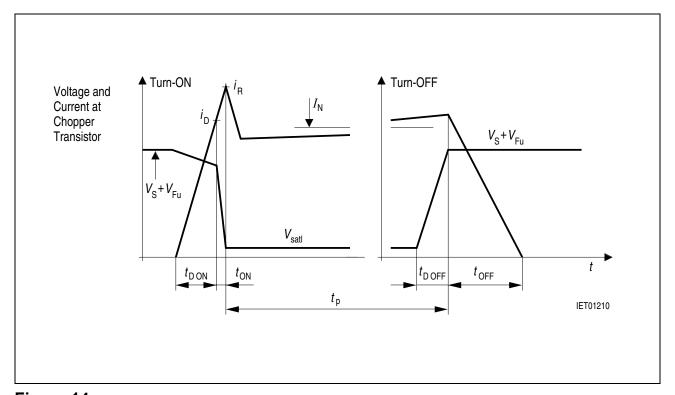


Figure 14



Application Hints

The TCA 3727 is intended to drive both phases of a stepper motor. Special care has been taken to provide high efficiency, robustness and to minimize external components.

Power Supply

The TCA 3727 will work with supply voltages ranging from 5 V to 50 V at pin $V_{\rm S}$. As the circuit operates with chopper regulation of the current, interference generation problems can arise in some applications. Therefore the power supply should be decoupled by a 0.22 μF ceramic capacitor located near the package. Unstabilized supplies may even afford higher capacities.

Current Sensing

The current in the windings of the stepper motor is sensed by the voltage drop across R_1 and R_2 . Depending on the selected current internal comparators will turn off the sink transistor as soon as the voltage drop reaches certain thresholds (typical 0 V, 0.25 V, 0.5 V and 0.75 V); $(R_1, R_2 = 1 \ \Omega)$. These thresholds are neither affected by variations of V_L nor by variations of V_S .

Due to chopper control fast current rises (up to 10 A/ μ s) will occur at the sensing resistors R_1 and R_2 . To prevent malfunction of the current sensing mechanism R_1 and R_2 should be pure ohmic. The resistors should be wired to GND as directly as possible. Capacitive loads such as long cables (with high wire to wire capacity) to the motor should be avoided for the same reason.

Synchronizing Several Choppers

In some applications synchronous chopping of several stepper motor drivers may be desirable to reduce acoustic interference. This can be done by forcing the oscillator of the TCA 3727 by a pulse generator overdriving the oscillator loading currents (approximately $\geq \pm 100~\mu A$). In these applications low level should be between 0 V and 1 V while high level should be between 2.6 V and $V_{\rm L}$.

Optimizing Noise Immunity

Unused inputs should always be wired to proper voltage levels in order to obtain highest possible noise immunity.

To prevent crossconduction of the output stages the TCA 3727 uses a special break before make timing of the power transistors. This timing circuit can be triggered by short glitches (some hundred nanoseconds) at the Phase inputs causing the output stage to become high resistive during some microseconds. This will lead to a fast current decay during that time. To achieve maximum current accuracy such glitches at the Phase inputs should be avoided by proper control signals.

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Thermal Shut Down

To protect the circuit against thermal destruction, thermal shut down has been implemented. To provide a warning in critical applications, the current of the sensing element is wired to input Inhibit. Before thermal shut down occurs Inhibit will start to pull down by some hundred microamperes. This current can be sensed to build a temperature prealarm.

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Package Outlines

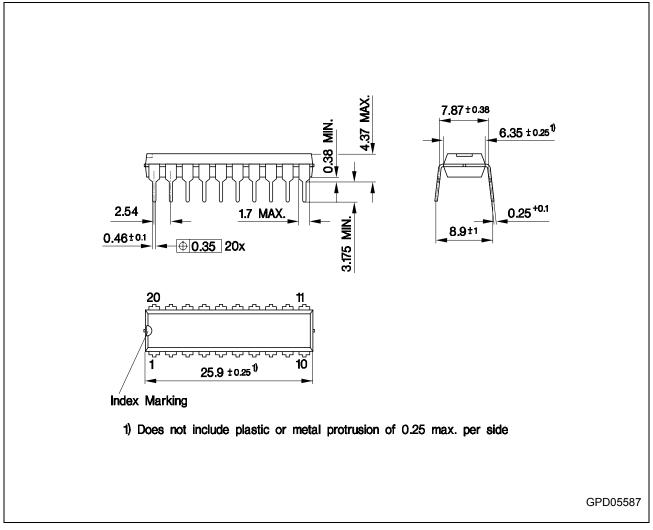


Figure 15 P-DIP-20-6 (Plastic Dual In-line Package)



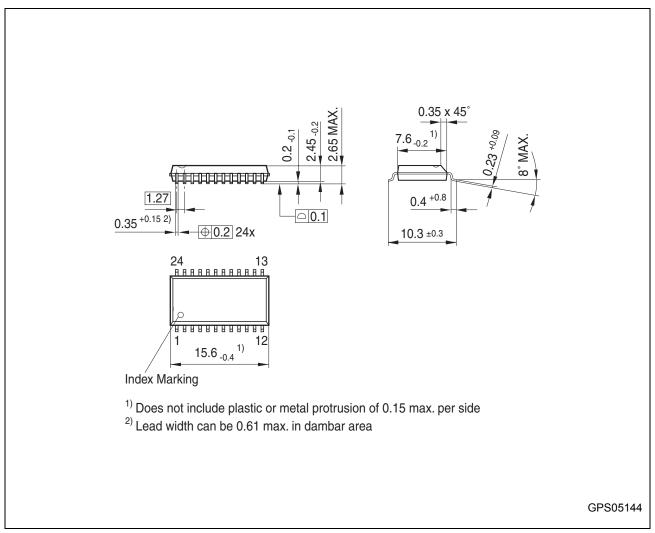


Figure 16 P-DSO-24-3 (Plastic Dual Small Outline Package)

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.

Dimensions in mm

Revision History:		2004-10-01	Rev. 2.0
Previous Ve	ersion:	1.0, 1998-12-16	
Page Subjects (m		ajor changes since last revision)	

TCA 3727

Edition 2004-10-01

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